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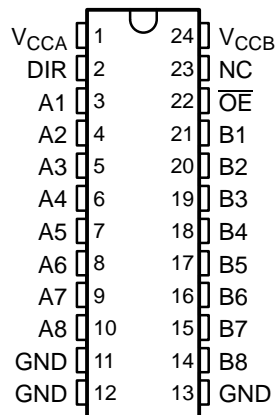
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Jameco Part Number 1048591

FEATURES

- Bidirectional Voltage Translator
- 2.3 V to 3.6 V on A Port and 3 V to 5.5 V on B Port
- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

 DB, DBQ, DW, NS, OR PW PACKAGE
(TOP VIEW)


NC - No internal connection

DESCRIPTION/ORDERING INFORMATION

This 8-bit (octal) noninverting bus transceiver contains two separate supply rails. The B port is designed to track V_{CCB} , which accepts voltages from 3 V to 5.5 V, and the A port is designed to track V_{CCA} , which operates at 2.3 V to 3.6 V. This allows for translation from a 3.3-V to a 5-V system environment and vice versa, from a 2.5-V to a 3.3-V system environment and vice versa.

The SN74LVCC3245A is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so the buses are effectively isolated. The control circuitry (DIR, \overline{OE}) is powered by V_{CCA} .

ORDERING INFORMATION

| T_A | PACKAGE ⁽¹⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|------------------------|--------------|-----------------------|------------------|
| -40°C to 85°C | SOIC – DW | Tube of 25 | SN74LVCC3245ADW | LVCC3245A |
| | | Reel of 2000 | SN74LVCC3245ADWR | |
| | SOP – NS | Reel of 2000 | SN74LVCC3245ANSR | LVCC3245A |
| | SSOP – DB | Reel of 2000 | SN74LVCC3245ADBR | LH245A |
| | SSOP (QSOP) – DBQ | Reel of 2500 | SN74LVCC3245ADBQR | LVCC3245A |
| | TSSOP – PW | Tube of 60 | SN74LVCC3245APW | LH245A |
| | | Reel of 2000 | SN74LVCC3245APWR | |
| | | Reel of 250 | SN74LVCC3245APWT | |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE (EACH TRANSCEIVER)

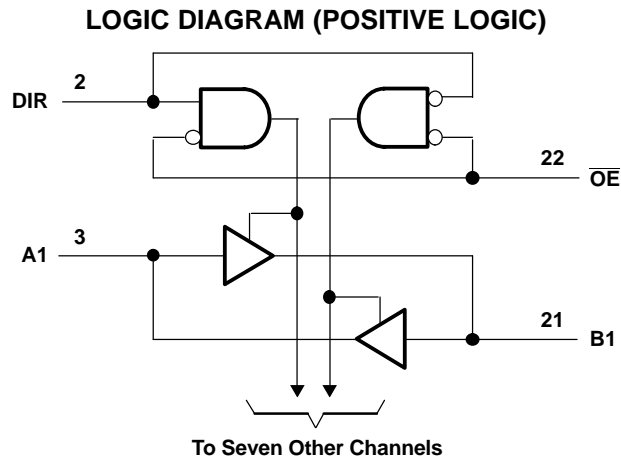
| INPUTS | | OPERATION |
|-----------------|-----|-----------------|
| \overline{OE} | DIR | |
| L | L | B data to A bus |
| L | H | A data to B bus |
| H | X | Isolation |



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SN74LVCC3245A
OCTAL BUS TRANSCEIVER
WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

SCAS5850–NOVEMBER 1996–REVISED MARCH 2005



Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | MIN | MAX | UNIT | |
|------------------------|---|---------------------------------|-----------|-----------------|------|
| V_{CCA} V_{CCB} | Supply voltage range | -0.5 | 6 | V | |
| V_I | Input voltage range | All A ports ⁽²⁾ | -0.5 | $V_{CCA} + 0.5$ | V |
| | | All B ports ⁽³⁾ | -0.5 | $V_{CCB} + 0.5$ | |
| | | Except I/O ports ⁽²⁾ | -0.5 | $V_{CCA} + 0.5$ | |
| V_O | Output voltage range ⁽³⁾ | All A ports | -0.5 | $V_{CCA} + 0.5$ | V |
| | | All B ports | -0.5 | $V_{CCB} + 0.5$ | |
| I_{IK} | Input clamp current | | $V_I < 0$ | -50 | mA |
| I_{OK} | Output clamp current | | $V_O < 0$ | -50 | mA |
| I_O | Continuous output current | | | ±50 | mA |
| | Continuous current through V_{CCA} , V_{CCB} , or GND | | | ±100 | mA |
| θ_{JA} | Package thermal impedance ⁽⁴⁾ | DB package | | 63 | °C/W |
| | | DBQ package | | 61 | |
| | | DW package | | 46 | |
| | | NS package | | 65 | |
| | | PW package | | 88 | |
| T_{stg} | Storage temperature range | -65 | 150 | °C | |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) This value is limited to 4.6 V maximum.
- (3) This value is limited to 6 V maximum.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

Recommended Operating Conditions⁽¹⁾

| | | V _{CCA} | V _{CCB} | MIN | NOM | MAX | UNIT |
|------------------|--|------------------|------------------|------|-----|------------------|------|
| V _{CCA} | Supply voltage | | | 2.3 | 3.3 | 3.6 | V |
| V _{CCB} | Supply voltage | | | 3 | 5 | 5.5 | V |
| V _{IHA} | High-level input voltage | 2.3 V | 3 V | 1.7 | | | V |
| | | 2.7 V | 3 V | 2 | | | |
| | | 3 V | 3.6 V | 2 | | | |
| | | 3.6 V | 5.5 V | 2 | | | |
| V _{IHB} | High-level input voltage | 2.3 V | 3 V | 2 | | | V |
| | | 2.7 V | 3 V | 2 | | | |
| | | 3 V | 3.6 V | 2 | | | |
| | | 3.6 V | 5.5 V | 3.85 | | | |
| V _{ILA} | Low-level input voltage | 2.3 V | 3 V | | | 0.7 | V |
| | | 2.7 V | 3 V | | | 0.8 | |
| | | 3 V | 3.6 V | | | 0.8 | |
| | | 3.6 V | 5.5 V | | | 0.8 | |
| V _{ILB} | Low-level input voltage | 2.3 V | 3 V | | | 0.8 | V |
| | | 2.7 V | 3 V | | | 0.8 | |
| | | 3 V | 3.6 V | | | 0.8 | |
| | | 3.6 V | 5.5 V | | | 1.65 | |
| V _{IH} | High-level input voltage (control pins) (referenced to V _{CCA}) | 2.3 V | 3 V | 1.7 | | | V |
| | | 2.7 V | 3 V | 2 | | | |
| | | 3 V | 3.6 V | 2 | | | |
| | | 3.6 V | 5.5 V | 2 | | | |
| V _{IL} | Low-level input voltage (control pins) (referenced to V _{CCA}) | 2.3 V | 3 V | | | 0.7 | V |
| | | 2.7 V | 3 V | | | 0.8 | |
| | | 3 V | 3.6 V | | | 0.8 | |
| | | 3.6 V | 5.5 V | | | 0.8 | |
| V _{IA} | Input voltage | | | 0 | | V _{CCA} | V |
| V _{IB} | Input voltage | | | 0 | | V _{CCB} | V |
| V _{OA} | Output voltage | | | 0 | | V _{CCA} | V |
| V _{OB} | Output voltage | | | 0 | | V _{CCB} | V |
| I _{OHA} | High-level output current | 2.3 V | 3 V | | | –8 | mA |
| | | 2.7 V | 3 V | | | –12 | |
| | | 3 V | 3 V | | | –24 | |
| | | 2.7 V | 4.5 V | | | –24 | |
| I _{OHB} | High-level output current | 2.3 V | 3 V | | | –12 | mA |
| | | 2.7 V | 3 V | | | –12 | |
| | | 3 V | 3 V | | | –24 | |
| | | 2.7 V | 4.5 V | | | –24 | |
| I _{OLA} | Low-level output current | 2.3 V | 3 V | | | 8 | mA |
| | | 2.7 V | 3 V | | | 12 | |
| | | 3 V | 3 V | | | 24 | |
| | | 2.7 V | 4.5 V | | | 24 | |

(1) All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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OCTAL BUS TRANSCEIVER
WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

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Recommended Operating Conditions (continued)

| | | V _{CCA} | V _{CCB} | MIN | NOM | MAX | UNIT |
|------------------|------------------------------------|------------------|------------------|-----|-----|-----|------|
| I _{OLB} | Low-level output current | 2.3 V | 3 V | | | 12 | mA |
| | | 2.7 V | 3 V | | | 12 | |
| | | 3 V | 3 V | | | 24 | |
| | | 2.7 V | 4.5 V | | | 24 | |
| Δt/Δv | Input transition rise or fall rate | | | | | 10 | ns/V |
| T _A | Operating free-air temperature | | | –40 | | 85 | °C |

Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | V _{CCA} | V _{CCB} | MIN | TYP | MAX | UNIT |
|----------------------------------|-------------------------|--|------------------|------------------|-----|------|-----|------|
| V _{OHA} | | I _{OH} = –100 μA | 3 V | 3 V | 2.9 | 3 | | V |
| | | I _{OH} = –8 mA | 2.3 V | 3 V | 2 | | | |
| | | I _{OH} = –12 mA | 2.7 V | 3 V | 2.2 | 2.5 | | |
| | | | 3 V | 3 V | 2.4 | 2.8 | | |
| | | I _{OH} = –24 mA | 3 V | 3 V | 2.2 | 2.6 | | |
| | 2.7 V | | 4.5 V | 2 | 2.3 | | | |
| V _{OHB} | | I _{OH} = –100 μA | 3 V | 3 V | 2.9 | 3 | | V |
| | | I _{OH} = –12 mA | 2.3 V | 3 V | 2.4 | | | |
| | | | 2.7 V | 3 V | 2.4 | 2.8 | | |
| | | I _{OH} = –24 mA | 3 V | 3 V | 2.2 | 2.6 | | |
| | 2.7 V | | 4.5 V | 3.2 | 4.2 | | | |
| V _{OLA} | | I _{OL} = 100 μA | 3 V | 3 V | | | 0.1 | V |
| | | I _{OL} = 8 mA | 2.3 V | 3 V | | | 0.6 | |
| | | I _{OL} = 12 mA | 2.7 V | 3 V | | 0.1 | 0.5 | |
| | | | 3 V | 3 V | | 0.2 | 0.5 | |
| | I _{OL} = 24 mA | 2.7 V | 4.5 V | | 0.2 | 0.5 | | |
| | | 2.7 V | 4.5 V | | 0.2 | 0.5 | | |
| V _{OLB} | | I _{OL} = 100 μA | 3 V | 3 V | | | 0.1 | V |
| | | I _{OL} = 12 mA | 2.3 V | 3 V | | | 0.4 | |
| | | | 3 V | 3 V | | 0.2 | 0.5 | |
| | | I _{OL} = 24 mA | 2.7 V | 4.5 V | | 0.2 | 0.5 | |
| | 2.7 V | | 4.5 V | | 0.2 | 0.5 | | |
| I _I | Control inputs | V _I = V _{CCA} or GND | 3.6 V | 3.6 V | | ±0.1 | ±1 | μA |
| | | | | 5.5 V | | ±0.1 | ±1 | |
| I _{OZ} ⁽¹⁾ | A or B ports | V _O = V _{CCA/B} or GND, V _I = V _{IL} or V _{IH} | 3.6 V | 3.6 V | | ±0.5 | ±5 | μA |
| I _{CCA} | B to A | A port = V _{CCA} or GND, I _O = 0 | 3.6 V | Open | | 5 | 50 | μA |
| | | B port = V _{CCB} or GND, I _O = 0 | 3.6 V | 3.6 V | | 5 | 50 | |
| | | | | 5.5 V | | 5 | 50 | |
| I _{CCB} | A to B | A port = V _{CCA} or GND, I _O = 0 | 3.6 V | 3.6 V | | 5 | 50 | μA |
| | | | | 5.5 V | | 8 | 80 | |
| ΔI _{CCA} ⁽²⁾ | A port | V _I = V _{CCA} – 0.6 V, Other inputs at V _{CCA} or GND, \overline{OE} at GND and DIR at V _{CCA} | 3.6 V | 3.6 V | | 0.35 | 0.5 | mA |
| | \overline{OE} | V _I = V _{CCA} – 0.6 V, Other inputs at V _{CCA} or GND, DIR at V _{CCA} | 3.6 V | 3.6 V | | 0.35 | 0.5 | |
| | DIR | V _I = V _{CCA} – 0.6 V, Other inputs at V _{CCA} or GND, \overline{OE} at GND | 3.6 V | 3.6 V | | 0.35 | 0.5 | |
| ΔI _{CCB} ⁽²⁾ | B port | V _I = V _{CCB} – 2.1 V, Other inputs at V _{CCB} or GND, \overline{OE} at GND and DIR at GND | 3.6 V | 5.5 V | | 1 | 1.5 | mA |
| C _i | Control inputs | V _I = V _{CCA} or GND | Open | Open | | 4 | | pF |
| C _{io} | A or B ports | V _O = V _{CCA/B} or GND | 3.3 V | 5 V | | 18.5 | | pF |

 (1) For I/O ports, the parameter I_{OZ} includes the input leakage current.

 (2) This is the increase in supply current for each input that is at one of the specified voltage levels, rather than 0 V or the associated V_{CC}.

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OCTAL BUS TRANSCEIVER
WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS



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Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 4)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$, $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}$, $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}$, $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | UNIT |
|-----------|-----------------|-------------|--|------|--|-----|--|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{PHL} | A | B | 1 | 9.4 | 1 | 6 | 1 | 7.1 | ns |
| t_{PLH} | | | 1 | 9.1 | 1 | 5.3 | 1 | 7.2 | |
| t_{PHL} | B | A | 1 | 11.2 | 1 | 5.8 | 1 | 6.4 | ns |
| t_{PLH} | | | 1 | 9.9 | 1 | 7 | 1 | 7.6 | |
| t_{PZL} | \overline{OE} | A | 1 | 14.5 | 1 | 9.2 | 1 | 9.7 | ns |
| t_{PZH} | | | 1 | 12.9 | 1 | 9.5 | 1 | 9.5 | |
| t_{PZL} | \overline{OE} | B | 1 | 13 | 1 | 8.1 | 1 | 9.2 | ns |
| t_{PZH} | | | 1 | 12.8 | 1 | 8.4 | 1 | 9.9 | |
| t_{PLZ} | \overline{OE} | A | 1 | 7.1 | 1 | 7 | 1 | 6.6 | ns |
| t_{PHZ} | | | 1 | 6.9 | 1 | 7.8 | 1 | 6.9 | |
| t_{PLZ} | \overline{OE} | B | 1 | 8.8 | 1 | 7.3 | 1 | 7.5 | ns |
| t_{PHZ} | | | 1 | 8.9 | 1 | 7 | 1 | 7.9 | |

Operating Characteristics

$V_{CCA} = 3.3\text{ V}$, $V_{CCB} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

| PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|-----------|---|----------------------------------|------------------|------|
| C_{pd} | Power dissipation capacitance per transceiver | $C_L = 50$, $f = 10\text{ MHz}$ | 38 | pF |
| | | | Outputs enabled | |
| | | | 4.5 | |
| | | | Outputs disabled | |

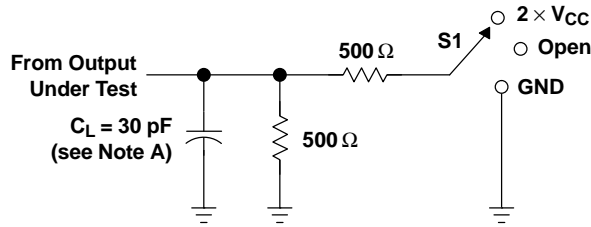
Power-Up Considerations⁽¹⁾

TI level-translation devices offer an opportunity for successful mixed-voltage signal design. A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device pins. To guard against such power-up problems, take these precautions:

1. Connect ground before any supply voltage is applied.
2. Power up the control side of the device (V_{CCA} for all four of these devices).
3. Tie \overline{OE} to V_{CCA} with a pullup resistor so that it ramps with V_{CCA} .
4. Depending on the direction of the data path, DIR can be high or low. If DIR high is needed (A data to B bus), ramp it with V_{CCA} . Otherwise, keep DIR low.

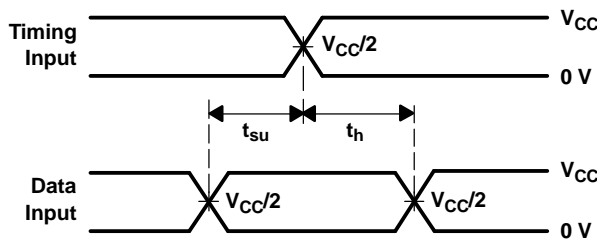
(1) Refer to the TI application report, *Texas Instruments Voltage-Level-Translation Devices*, literature number SCEA021.

PARAMETER MEASUREMENT INFORMATION FOR A PORT
 $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$ AND $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$

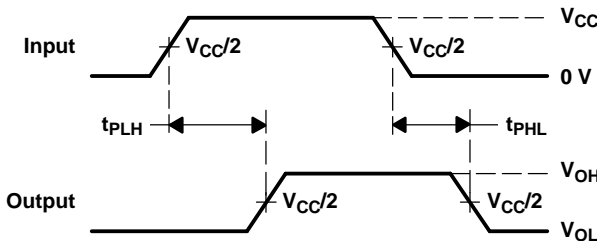


LOAD CIRCUIT

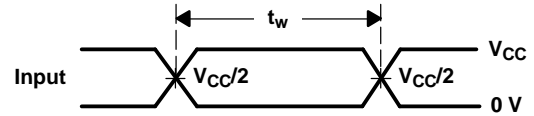
| TEST | S1 |
|-------------------|-------------------|
| t_{pd} | Open |
| t_{PLZ}/t_{PZL} | $2 \times V_{CC}$ |
| t_{PHZ}/t_{PZH} | GND |



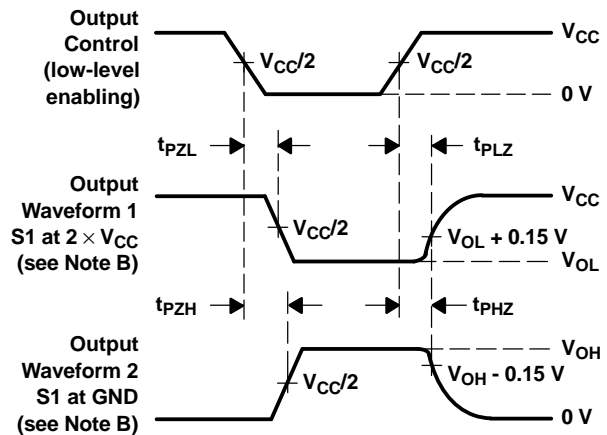
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2\text{ ns}$, $t_f \leq 2\text{ ns}$.
 D. The outputs are measured one at a time, with one transition per measurement.
 E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 F. t_{PZL} and t_{PZH} are the same as t_{en} .
 G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 H. All parameters and waveforms are not applicable to all devices.

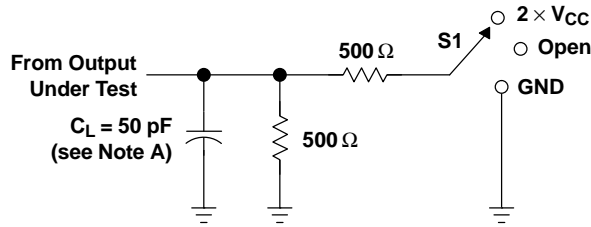
Figure 1. Load Circuit and Voltage Waveforms

SN74LVCC3245A
OCTAL BUS TRANSCEIVER
WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

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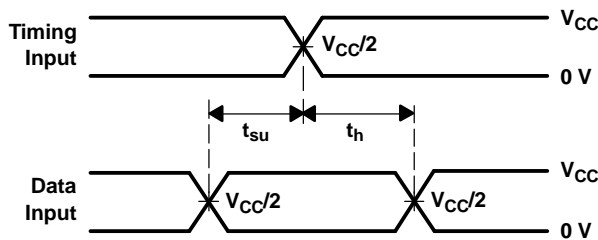
PARAMETER MEASUREMENT INFORMATION FOR B PORT

$V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ AND $V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$

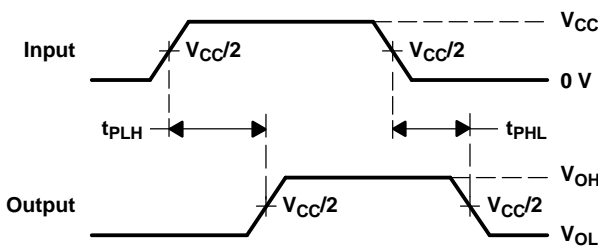


LOAD CIRCUIT

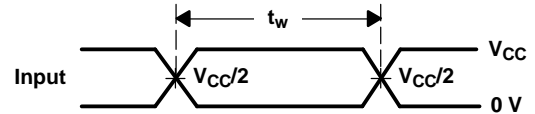
| TEST | S1 |
|-------------------|-------------------|
| t_{pd} | Open |
| t_{PLZ}/t_{PZL} | 2 $\times V_{CC}$ |
| t_{PHZ}/t_{PZH} | GND |



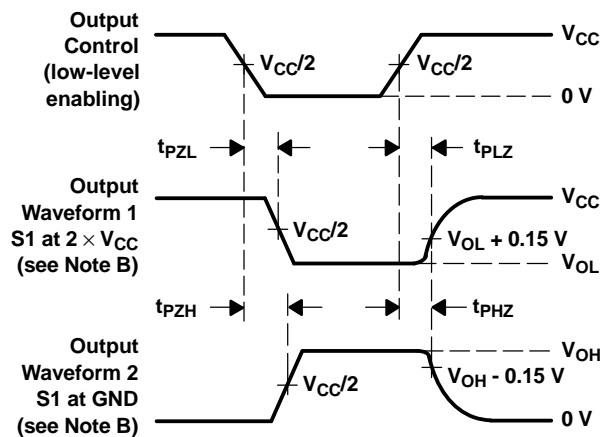
**VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES**



**VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES**



**VOLTAGE WAVEFORMS
PULSE DURATION**

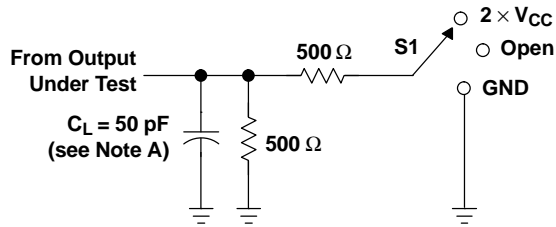


**VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES**

- NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2 \text{ ns}$, $t_f \leq 2 \text{ ns}$.
D. The outputs are measured one at a time, with one transition per measurement.
E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
F. t_{PZL} and t_{PZH} are the same as t_{en} .
G. t_{PLH} and t_{PHL} are the same as t_{pd} .
H. All parameters and waveforms are not applicable to all devices.

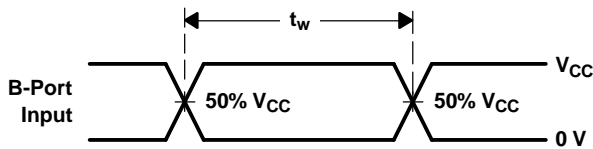
Figure 2. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION FOR B PORT
 $V_{CCA} = 3.6\text{ V}$ and $v_{CCB} = 5.5\text{ V}$

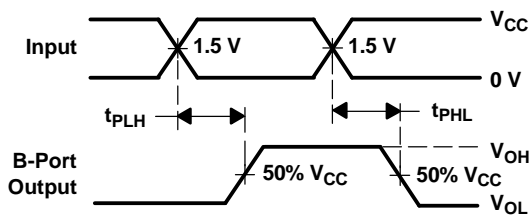


LOAD CIRCUIT

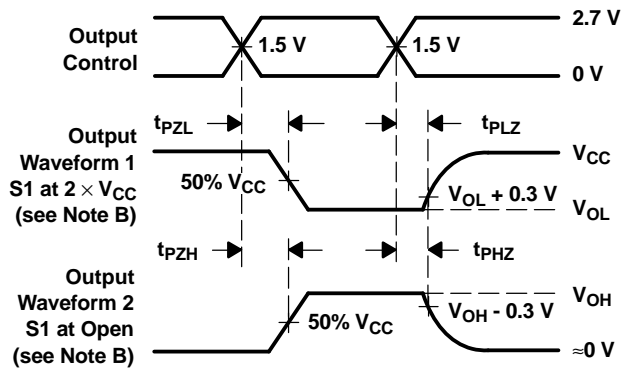
| TEST | S1 |
|-------------------|-------------------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | $2 \times V_{CC}$ |
| t_{PHZ}/t_{PZH} | Open |



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
NONINVERTING OUTPUTS

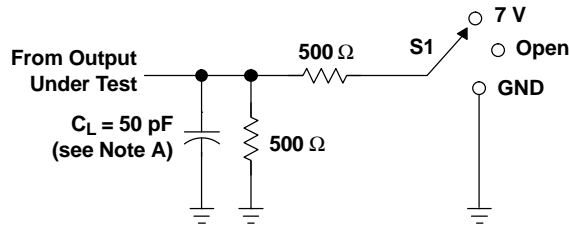


VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 D. The outputs are measured one at a time, with one transition per measurement.
 E. All parameters and waveforms are not applicable to all devices.

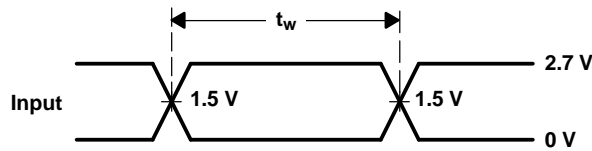
Figure 3. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION FOR A AND B PORT
 V_{CCA} AND $V_{CCB} = 3.6\text{ V}$

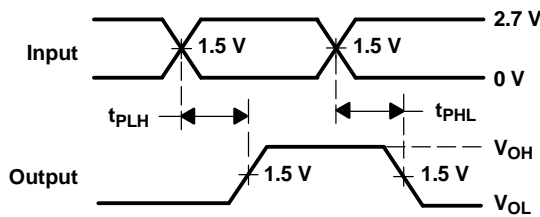


| TEST | S1 |
|-------------------|------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | 7 V |
| t_{PHZ}/t_{PZH} | Open |

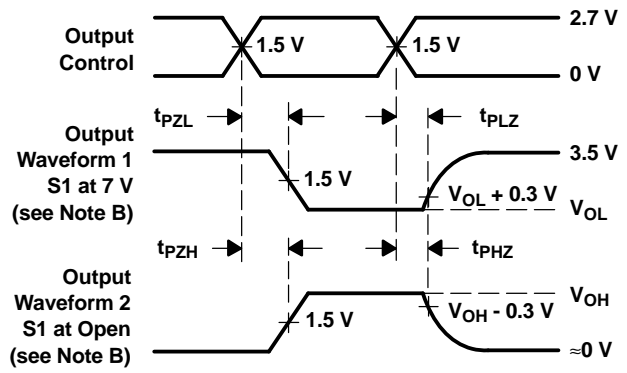
LOAD CIRCUIT



VOLTAGE WAVEFORMS
 PULSE DURATION



VOLTAGE WAVEFORMS
 PROPAGATION DELAY TIMES
 NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
 ENABLE AND DISABLE TIMES
 LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 D. The outputs are measured one at a time, with one transition per measurement.
 E. All parameters and waveforms are not applicable to all devices.

Figure 4. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|--------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 74LVCC3245ADBQRE4 | ACTIVE | SSOP/QSOP | DBQ | 24 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| 74LVCC3245ADBQRG4 | ACTIVE | SSOP/QSOP | DBQ | 24 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| SN74LVCC3245ADBLE | OBSOLETE | SSOP | DB | 24 | | TBD | Call TI | Call TI |
| SN74LVCC3245ADBQR | ACTIVE | SSOP/QSOP | DBQ | 24 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| SN74LVCC3245ADBR | ACTIVE | SSOP | DB | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245ADBRE4 | ACTIVE | SSOP | DB | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245ADBRG4 | ACTIVE | SSOP | DB | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245ADW | ACTIVE | SOIC | DW | 24 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245ADWE4 | ACTIVE | SOIC | DW | 24 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245ADWG4 | ACTIVE | SOIC | DW | 24 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245ADWR | ACTIVE | SOIC | DW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245ADWRE4 | ACTIVE | SOIC | DW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245ADWRG4 | ACTIVE | SOIC | DW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245ANSR | ACTIVE | SO | NS | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245ANSRE4 | ACTIVE | SO | NS | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245ANSRG4 | ACTIVE | SO | NS | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245APW | ACTIVE | TSSOP | PW | 24 | 60 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245APWE4 | ACTIVE | TSSOP | PW | 24 | 60 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245APWG4 | ACTIVE | TSSOP | PW | 24 | 60 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245APWLE | OBSOLETE | TSSOP | PW | 24 | | TBD | Call TI | Call TI |
| SN74LVCC3245APWR | ACTIVE | TSSOP | PW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245APWRE4 | ACTIVE | TSSOP | PW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245APWRG4 | ACTIVE | TSSOP | PW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245APWT | ACTIVE | TSSOP | PW | 24 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245APWTE4 | ACTIVE | TSSOP | PW | 24 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCC3245APWTG4 | ACTIVE | TSSOP | PW | 24 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| no Sb/Br) | | | | | | | | |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

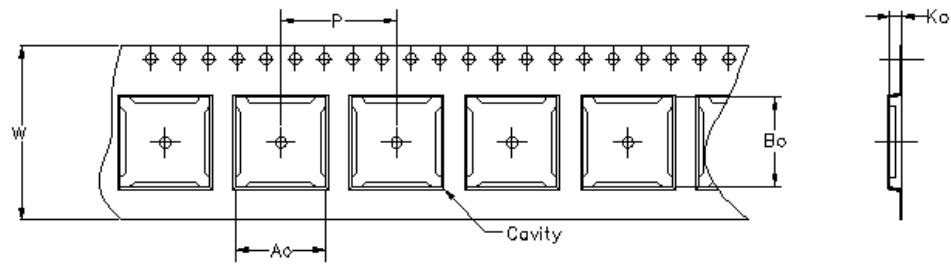
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

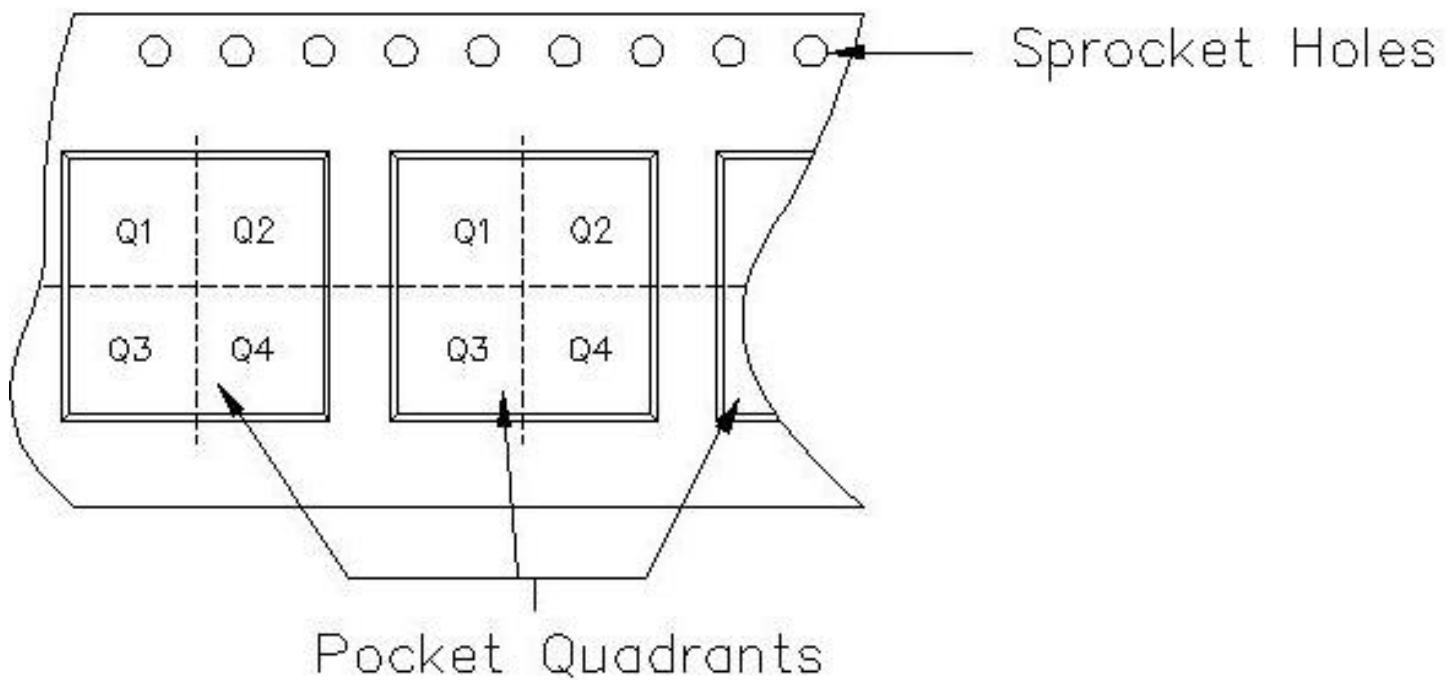
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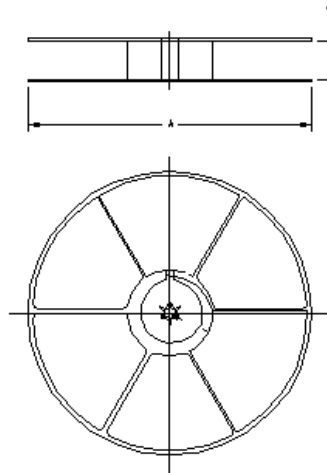
Carrier tape design is defined largely by the component length, width, and thickness.

| |
|--|
| A_o = Dimension designed to accommodate the component width. |
| B_o = Dimension designed to accommodate the component length. |
| K_o = Dimension designed to accommodate the component thickness. |
| W = Overall width of the carrier tape. |
| P = Pitch between successive cavity centers. |



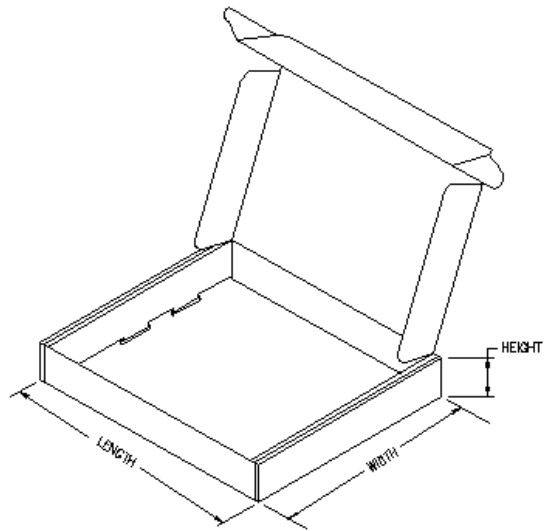
TAPE AND REEL INFORMATION

| Device | Package | Pins | Site | Reel Diameter (mm) | Reel Width (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|---------|------|------|--------------------|-----------------|---------|---------|---------|---------|--------|---------------|
| SN74LVCC3245ADBQR | DBQ | 24 | MLA | 330 | 16 | 6.5 | 9.0 | 2.1 | 8 | 16 | Q1 |
| SN74LVCC3245ADBR | DB | 24 | MLA | 330 | 16 | 8.2 | 8.8 | 2.5 | 12 | 16 | Q1 |
| SN74LVCC3245ADWR | DW | 24 | TAI | 330 | 24 | 10.75 | 15.7 | 2.7 | 12 | 24 | Q1 |
| SN74LVCC3245ANSR | NS | 24 | MLA | 330 | 24 | 8.2 | 15.4 | 2.5 | 12 | 24 | Q1 |
| SN74LVCC3245APWR | PW | 24 | MLA | 330 | 16 | 6.95 | 8.3 | 1.6 | 8 | 16 | Q1 |



TAPE AND REEL BOX INFORMATION

| Device | Package | Pins | Site | Length (mm) | Width (mm) | Height (mm) |
|-------------------|---------|------|------|-------------|------------|-------------|
| SN74LVCC3245ADBQR | DBQ | 24 | MLA | 346.0 | 346.0 | 33.0 |
| SN74LVCC3245ADBR | DB | 24 | MLA | 346.0 | 346.0 | 33.0 |
| SN74LVCC3245ADWR | DW | 24 | TAI | 346.0 | 346.0 | 41.0 |
| SN74LVCC3245ANSR | NS | 24 | MLA | 346.0 | 346.0 | 41.0 |
| SN74LVCC3245APWR | PW | 24 | MLA | 346.0 | 346.0 | 33.0 |



MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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